

April 2003 Revised July 2004

FSAT66

Low Voltage Single SPST Normally Open Analog Switch with TTL Compatible Control Input

General Description

The FSAT66 is a high speed single pole/single throw normally open Analog Switch with a TTL compatible control input and is fabricated on a sub-micron CMOS process.

The low On Resistance of the switch allows input to be connected to output with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a switch enable (OE) signal. When OE is HIGH, the switch is on and Port A is connected to Port B. When OE is LOW, the switch is open and a high-impedance state exists between the two ports.

Features

- Space saving SC70 5-lead package
- Ultra small MicroPak™ leadless package
- Broad V_{CC} Operating Range 1.65V to 5.5V
- Rail-to-rail signal handling
- \blacksquare 5Ω switch connection between two ports
- Minimal propagation delay through the switch
- Low I_{CC}
- Zero bounce in flow-through mode
- Control input compatible with TTL input levels
- >250 MHz-3dB bandwidth

Ordering Code:

		Product		
Order	Package	Code	Package Description	Supplied As
Number	Number	Top Mark		
FSAT66M5X (Preliminary)	MA05B	AT66	5-Lead SOT23, JEDEC MO-178, 1.6mm	3K Units on Tape and Reel
FSAT66P5X	MAA05A	T66	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3K Units on Tape and Reel
FSAT66L6X	MAC06A	EF	6-Lead MicroPak, 1.0mm Wide	5K Units on Tape and Reel

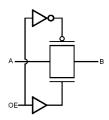
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DS500862

SATE

Logic Symbol



Pin Descriptions

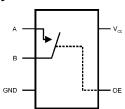
Pin Names	Description		
OE	Switch Enable Input		
A	Bus A I/O		
В	Bus B I/O		
NC	No Connect		

Function Table

OE	B ₀	Function
L	High-Z State	Disconnect
Н	A ₀	Connect

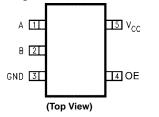
H = HIGH Logic Level L = LOW Logic Level

Analog Symbol

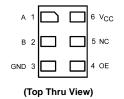


Connection Diagrams

Pin Assignments for SOT23 and SC70



Pad Assignments for MicroPak



Absolute Maximum Ratings(Note 1)

-0.5V to +7.0V Supply Voltage (V_{CC}) DC Switch Voltage (V_S) -0.5 V to $\text{V}_{\text{CC}} + 0.5 \text{V}$ DC Input Voltage (V_{IN}) (Note 2) -0.5V to +7.0V

DC Input Diode Current

@ $(I_{IK}) V_{IN} < 0V$ -50 mA DC Output (I_{OUT}) Sink Current ±128 mA DC V_{CC} or Ground Current (I_{CC}/I_{GND}) ±100 mA Storage Temperature Range (T_{STG}) $-65^{\circ}C$ to $+150^{\circ}C$

Junction Lead Temperature

under Bias (T_J) Junction Lead Temperature (T_L)

(Soldering, 10 Seconds) Power Dissipation (P_D) @ +85°C

SC70-5

150 mW MicroPak-6 200 mW

Recommended Operating Conditions (Note 3)

Power Supply Voltage (V_{CC}) 1.65V to 5.5V 0V to 5.5V Control Input Voltage (V_{IN}) Switch Input Voltage (V_{IN}) 0V to V_{CC} Switch Output Voltage (V_{OUT}) 0V to V_{CC}

Input Rise and Fall Time (t_r, t_f)

0 ns/V to 10 ns/V Control Input $V_{CC} = 2.3V$ to 3.6V 0 ns/V to 5 ns/V Control Input $V_{CC} = 4.5V$ to 5.5V 0 ns/V to DC Switch I/O Operating Temperature (T_A) -40°C to +85°C

Thermal Resistance (θ_{JA})

+150°C

+260°C

SC70-5 425°C/Watt MicroPak-6 325°C/Watt

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

	Parameter	V _{CC} (V)	T _A =	–40°C to	+85°C	$T_A = +25^{\circ}C$				
Symbol			Min	Typ (Note 4)	Max	Min	Тур	Max	Units	Conditions
V _{IH}	HIGH Level Input	4.5 to 5.5	2.0						V	
	Voltage	1.65 to 3.6	(0.25 V _{CC}	+ 0.75)					T *	
V _{IL}	LOW Level Input	4.5 to 5.5			8.0				V	
	Voltage	1.65 to 3.6			0.165 V _{CC}]	
I _{IN}	Control Input Leakage Current	0 to 5.5			±1.0				μА	0 ≤ V _{IN} ≤ 5.5V
I _{OFF}	OFF Leakage Current	1.65 to 5.5			±10.0				μΑ	$0 \le A, B \le V_{CC}$
R _{ON}	Switch On Resistance			3.0	7.0					$V_{IN} = 0V, I_{IN} = 30 \text{ mA}$
	(Note 5)	4.5		5.0	12.0					$V_{IN} = 2.4V, I_{IN} = 15 \text{ mA}$
				7.0	15.0					V _{IN} = 4.5V, I _{IN} = 30 mA
		3.0		4.0	9.0					V _{IN} = 0V, I _{IN} = 24 mA
		3.0		10.0	20.0				Ω	$V_{IN} = 3V$, $I_{IN} = 24 \text{ mA}$
		2.3		5.0	12.0				1	$V_{IN} = 0V$, $I_{IN} = 8 \text{ mA}$
		2.0		13.0	30.0					$V_{IN} = 2.3V, I_{IN} = 8 \text{ mA}$
		1.65		7.0	28.0					$V_{IN} = 0V$, $I_{IN} = 4$ mA
				25.0	60.0					$V_{IN} = 1.65V$, $I_{IN} = 4 \text{ mA}$
R _{flat}	On Resistance Flatness	5.0					6.0			$I_A = -30 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$
	(Note 5)(Note 6)	3.3					12.0		Ω	$I_A = -24 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$
	(Note 7)	2.5					28.0		32	$I_A = -8 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$
		1.8					125			$I_A = -4 \text{ mA}, \ 0 \le V_{Bn} \le V_{CC}$
I _{CC}	Quiescent Supply Current	1.65 to 5.5			10.0				μА	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0$

Note 4: All typical values are at the specified V_{CC} , and $T_A = 25$ °C.

Note 5: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 6: Parameter is characterized but not tested in production.

Note 7: Flatness is defined as the difference between the minimum and maximum value of On Resistance over the specified range of conditions.

AC Electrical Characteristics

Symbol		V _{CC}	T _A =	-40°C to +8	5°C			Figure
	Parameter	(V)	Min	Typ (Note 8)	Max	Units	Conditions	Number
t _{PHL} , t _{PLH}	Propagation Delay Bus to Bus	1.65 to 1.95		2.0	4.3			
	(Note 9)	2.3 to 2.7		1.1	2.5	ns	V _{IN} = OPEN	Figures
		3.0 to 3.6		0.7	1.5	115	VIN - OF LIV	1, 2
		4.5 to 5.5		0.35	1.0			
t _{PZL} , t _{PZH}	Output Enable Time	1.65 to 1.95	1.5	4.0	12.0			
		2.3 to 2.7	1.2	2.5	7.0		$V_{IN} = 2 \times V_{CC}$ for t_{PZL} $V_{IN} = 0V$ for t_{PZH}	Figures
		3.0 to 3.6	0.8	2.0	5.5	ns		1, 2
		4.5 to 5.5	0.5	1.5	4.5			
t _{PLZ} , t _{PHZ}	Output Disable Time	1.65 to 1.95	2.5	7.5	15.0	ns		
		2.3 to 2.7	2.0	5.5	9.0		$V_{IN} = 2 \times V_{CC}$ for t_{PLZ} $V_{IN} = 0V$ for t_{PHZ}	Figures
		3.0 to 3.6	1.5	4.5	7.0			1, 2
		4.5 to 5.5	1.0	3.5	5.5			
Q	Charge Injection (Note 10) 1.65 to 5			0.05		рC	$C_L = 0.1 \text{ nF}, V_{GEN} = 0V,$	Fig
							$R_{GEN} = 0 \Omega$, $f = 1 MHz$	Figure 3
OIRR	Off Isolation (Note 11)	1.65 to 5.5		-50.0		dB	$R_L = 50 \Omega$, $C_L = 5 pF$,	
							f = 10 MHz	Figure 4
BW	-3dB Bandwidth	1.65 to 5.5		>250		MHz	$R_L = 50 \Omega$	Figure 5
THD	Total Harmonic Distortion						$R_L = 600\Omega$	
	(Note 8) 5.0		.011		%	%	0.5 V _{P-P}	
							f = 600 Hz to 20 KHz	

Note 8: All typical values are at the specified V_{CC} , and T_A = 25°C.

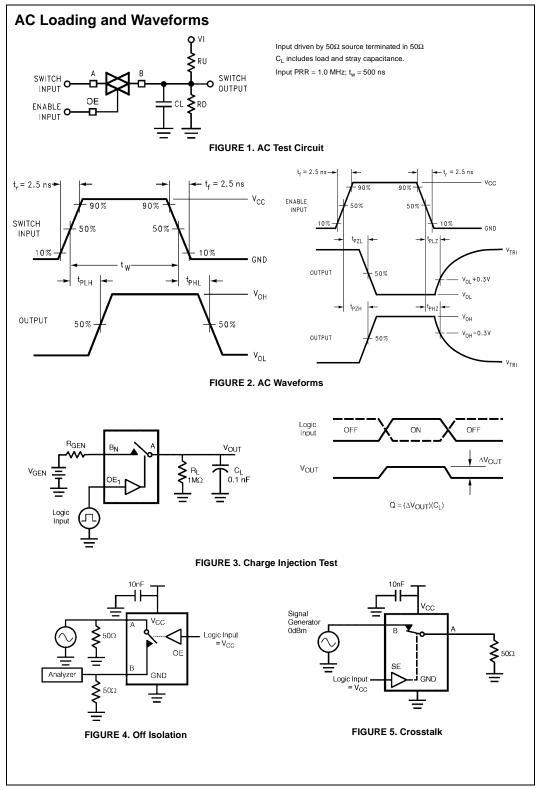
Note 9: This parameter is guaranteed by design but is not tested. The switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

Note 10: Guaranteed by design.

Note 11: Off Isolation = 20 $log_{10} [V_A/V_{Bn}]$

Capacitance

Symbol	Parameter	Тур	Max	Units	Conditions
C _{IN}	Control Pin Input Capacitance	2.0		pF	V _{CC} = 0V
C _{I/O OFF}	Input/Output Capacitance	6.0		pF	$V_{CC} = 5.0V, OE = 0.0V$
C _{I/O ON}	Input/Output Capacitance	12.0		pF	$V_{CC} = 5.0V$, $OE = V_{CC}$

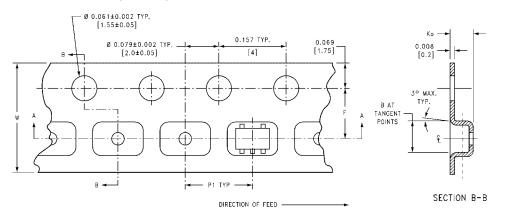


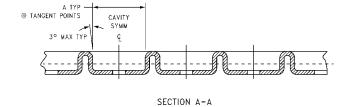
Tape and Reel Specification

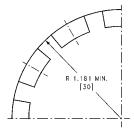
TAPE FORMAT FOR SOT23, SC70

Package	Tape	Number	Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
M5X, P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)

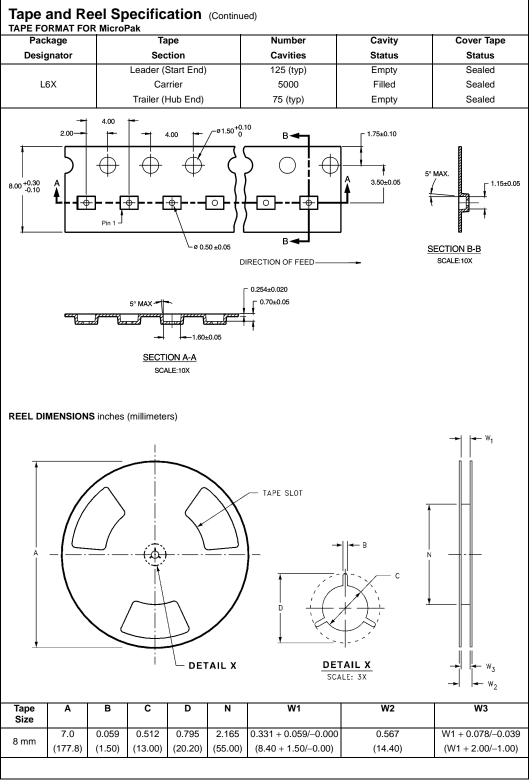


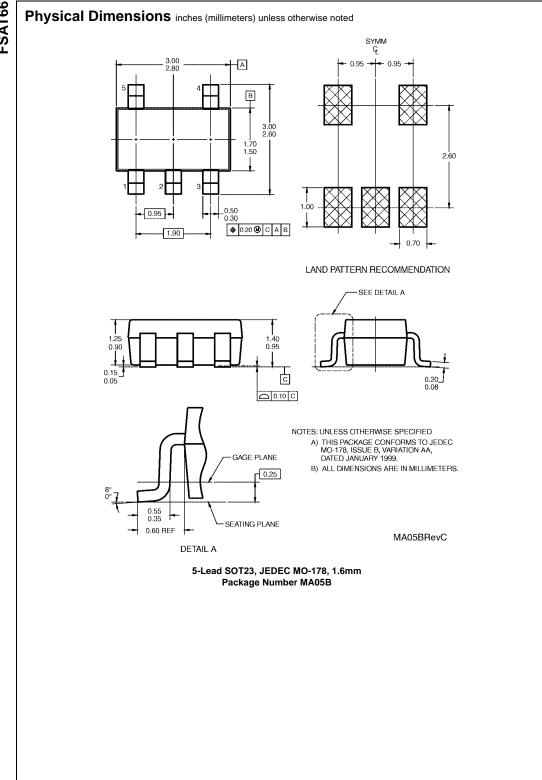


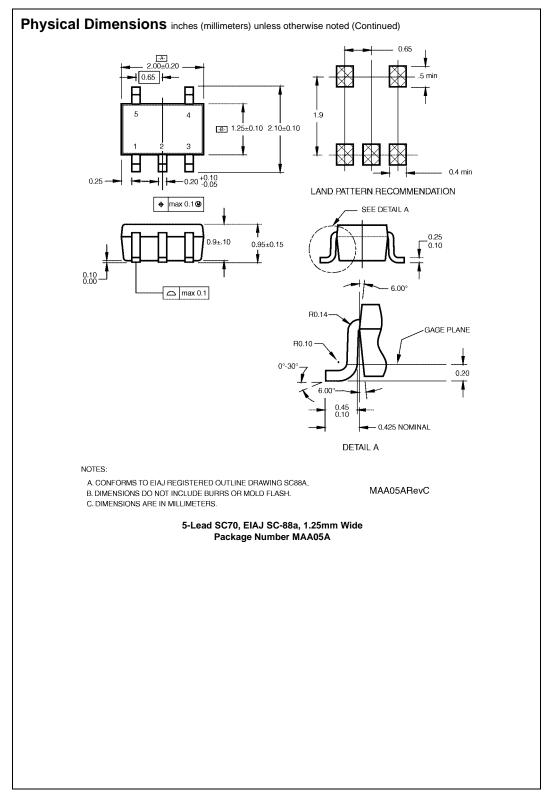


BEND RADIUS NOT TO SCALE

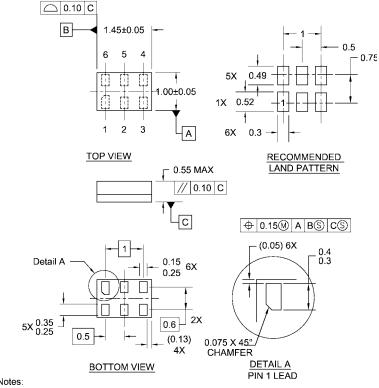
Package	Tape Size	DIM A	DIM B	DIM F	DIM K ₀	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
		(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)
SOT23-5	8 mm	0.130	0.130	0.138 ± 0.002	0.055 ± 0.004	0.157	0.315 ± 0.012
		(3.3)	(3.3)	(3.5 ± 0.05)	(1.4 ± 0.11)	(4)	(8 ± 0.3)







Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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